

STRUCTURE	Silicon Monolithic Integrated Circuit
PRODUCTNAME	BU7962GUW
FUNCTION	Serial Interface for Mobile Devices Application
	MSDL3(Mobile Shrink Data Link 3) Deserializer LSI
FEATURES	 Maximum transmission rate of highspeed differential interface MSDL3 i Support LCD interface with 24bit parallel RGB video mode. Pixel clock frequency is 4~30MHz

1. Absolute maximum

Parameter	Symbol	Rated values	Unit	Remarks
Power supply voltage for IOVDD	IOVDD	-0.3 ~ +4.5	V	
Power supply voltage for DVDD	DVDD	-0.3 ~ +2.5	V	
Power supply voltage for MSVDD	MSVDD	-0.3 ~ +2.5	V	
		-0.3 ~ IOVDD+0.3	V	I/O terminals of IOVDD line
Input voltage	VIN	-0.3 ~ +3.6	V	XSD terminal
		-0.3 ~ MSVDD+0.3	V	I/O terminals of MSVDD line
Input current	IIN	-10 ~ +10	mA	
Package power dissipation	Pd	300 *	mW	Without board mounted
Preservation temperature	Tstg	-55 ~ +125	С°	

*When it uses by Ta=25°C or higher, reduce by 3.0 mW/°C (for a single package).

2. Operating Condition

Parameter	Symbol	Min	Тур	Max	Unit	Remarks
Supply voltage for IOVDD	VIOVDD	1.65	1.80	3.60	V	
Supply voltage for DVDD	VDVDD	1.65	1.80	1.95	V	VDVDD=VMSVDD≤VIOVDD
Supply voltage for MSVDD	VMSVDD	1.65	1.80	1.95	V	
SubLVDS data rate	DR	120	-	450	Mbps/ch	
Operating temperature range	Topr	-30	25	+85	°C	

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1/4

is 900Mbps.

ROHM

3. ELECTRICAL CHARACTERISTICS

3.1 CMOS INOUT CHARACTERISTICS

Ta=25°C, DVDD=MSVDD=1.80V, IOVDD=1.80V, DGND=MSGND=0.00V, unless otherwise noted

Parameter	Symbol	Min	Тур	Max	Unit		ditions
'L' input voltage1	VIL1	DGND	-	0.3*IOVDD	V	POL_PCL PLL_BW[1	
'H' input voltage1	VIH1	0.7*IOVDD	-	IOVDD	V	LS0, F_XS terminals	
'L' input voltage2	VIL2	MSGND	-	0.3*MSVDD	V		N torminale
'H' input voltage2	VIH2	0.7*MSVDD	-	MSVDD	V	LS1, LS_EN terminals	
'H' input voltage3	VIH3	0.7*IOVDD	-	3.6	V	XSD termi	nal
'L' output voltage1	VOL1	DGND	-	0.3*IOVDD	V	IO=1mA	F_XS=L, PCLK, CPO,
'H' output voltage1	VOH1	0.7*IOVDD	-	IOVDD	V	IO=-1mA	PD[26:0] terminals
'L' output voltage2	VOL2	DGND	-	0.3*IOVDD	V	IO=3mA	F_XS=H, PCLK, CPO,
'H' output voltage2	VOH2	0.7*IOVDD	-	IOVDD	V	IO=-3mA	PD[26:0] terminals
PCLK frequency1	fPCLK1	4.0	-	15.0	MHz	LS0=L	PCLK
PCLK frequency2	fPCLK2	8.0	-	30.0	MHz	LS0=H	terminal
PCLK duty cycle	DPCLKO	40	50	60	%	PCLK term	ninal
Data setup to PCLK	TDSO	10.0	-	-	ns		arminala
Data hold to PCLK	tDHO	10.0	-	-	ns	PD[26:0] to	

3.2 MSDL3 RX CHARACTERISTICS

Ta=25°C, DVDD=MSVDD=1.80V, IOVDD=1.80V, DGND=MSGND=0.00V, unless otherwise noted

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Differential voltage range	Vdiff_rx	70	100	200	mVpp	
Common mode voltage range	Vcm_rx	0.6	0.9	1.2	V	
RX pull down current	lpull_rx	12	30	90	μA	
Threshold voltage of RX link detection	Vlink_rx	0.2	0.3	0.4	V	
SubLVDS data rate	DR_rx	120	-	450	Mbps/ch	

3.3 CURRENT COMSUMPTION

Ta=25°C, DVDD=MSVDD=1.80V, IOVDD=1.80V, DGND=MSGND=0.00V, unless otherwise noted

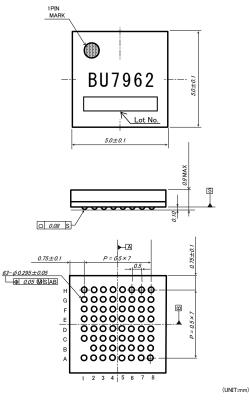
Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Shutdown current	lop_sht_rx	-	0.2	10.0	μA	XSD=L
Standby current	lop_stb_rx	-	41.8	90.0	μA	XSD=H
Active current of 1ch27bit format	lop_act_rx1	-	17.6	24.0	mA	LS[1:0]=LL, PLL_BW[1:0]=HL, fPCLK=15MHz, CL=10pF, *1
Active current of 2ch27bit format	lop_act_rx2	-	28.0	36.8	mA	LS[1:0]=LH, PLL_BW[1:0]=HL, fPCLK=30MHz, CL=10pF, *1
Active current of 1ch13bit format	lop_act_rx3	-	17.6	23.5	mA	LS[1:0]=HH, PLL_BW[1:0]=HL, fPCLK=30MHz, CL=10pF, *2

*1 : Total operating current(IDVDD+IMSVDD+IIOVDD) with PD[26:0] outputs toggling 0x2AAAAAA and 0x5555555.

*2 : Total operating current(IDVDD+IMSVDD+IIOVDD) with PD[26:15],PD[2] outputs toggling 0x0AAA and 0x1555.



4. PACKAGE VIEW

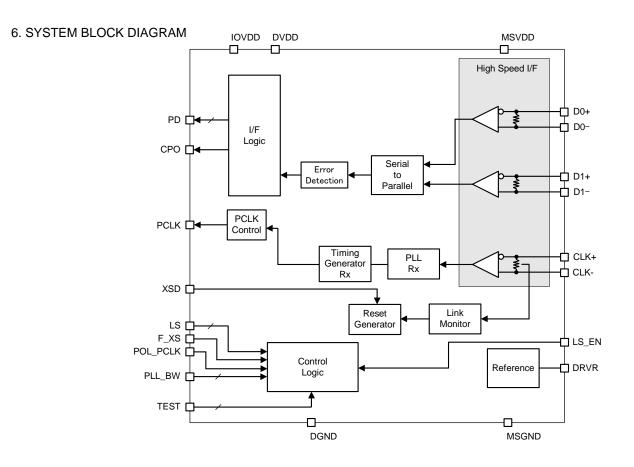


TESTO PD22 CP0 G1 **A**1 D1 A2 PD18 D2 PD20 G2 F XS POL PCLK A3 PD16 D3 G3 DRVR A4 PD15 D4 DGND G4 MSGND Α5 PD13 D5 DGND G5 MSVDD PD12 D6 IOVDD G6 LS1 A6 PD9 PD3 Α7 D7 G7 LS_EN TEST2 D8 PD4 G8 **A**8 XSD PD24 H1 B1 E1 TESTA B2 PCLK E2 PD23 H2 D1+ B3 PD17 IOVDD H3 D1-E3 PD14 H4 Β4 E4 DGND CLK+ B5 PD11 E5 MSGND H5 CLK-B6 PD10 E6 PLL BWO H6 D0+ B7 PD8 E7 PD0 H7 D0-PD7 E8 PD2 TEST1 B8 H8 C1 F1 PD25 PD21 C2 PD19 F2 PD26 C3 DVDD F3 MSVDD C4 IOVDD F4 MSGND C5 TEST3 F5 MSVDD C6 DVDD F6 LS0 C7 PD6 F7 PLL_BW1 PD5

F8

PD1

VBGA063W050



Pin

name

Pin

No.

Pin

name

Pin

No.

Pin

name

Pin

No.

C8



7. USAGE PRECAUTIONS

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operatingconditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

(3) Reverse connection of power supply connector The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

(4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines. In this regard, for the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner.

Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.
 (5) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

(7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

(9) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the guaranteed value of electrical characteristics.

(10) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

(11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(12) No Connecting input terminals

In terms of extremely high impedance of CMOS gate, to open the input terminals causes unstable state. And unstable state brings the inside gate voltage of p-channel or n-channel transistor into active. As a result, battery current may increase. And unstable state can also causes unexpected operation of IC. So unless otherwise specified, input terminals not being used should be connected to the power supply or GND line.

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